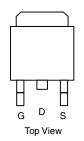


### Vishay Siliconix

# P-Channel 60 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
- 60	0.019 at V <sub>GS</sub> = - 10 V	- 55	76			
	0.025 at V <sub>GS</sub> = - 4.5 V	- 48	70			

#### TO-263

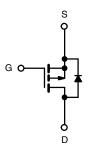


Ordering Information: SUM55P06-19L-E3 (Lead (Pb)-free)

### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> =	25 °C, unless othe	rwise noted)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 60	V		
Gate-Source Voltage	V <sub>GS</sub>	± 20	- V		
Continuous Durin Oursent <sup>d</sup> (T. 175 °C)	T <sub>C</sub> = 25 °C		- 55		
Continuous Drain Current <sup>d</sup> (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 125 °C	I <sub>D</sub>	- 31	_	
Pulsed Drain Current	I <sub>DM</sub>	- 150	A		
Avalanche Current		I <sub>AS</sub>	- 45		
Single Pulse Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	101	mJ	
Deven Dissistantian	T <sub>C</sub> = 25 °C		125 <sup>c</sup>		
Power Dissipation	$T_{C} = 25 \text{ °C}$ $T_{A} = 25 \text{ °C}^{b}$	P <sub>D</sub>	3.75	W	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount <sup>b</sup>	R <sub>thJA</sub>	40	°C/W		
Junction-to-Case		R <sub>thJC</sub>	1.2	0/11		

Notes:

a. Duty cycle  $\leq 1\%$ .

b. When mounted on 1" square PCB (FR-4 material).

c. See SOA curve for voltage derating.

d. Limited by package.

# SUM55P06-19L

## Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		· · ·					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = - 250 µA	- 60			v	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	- 1		- 3	v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	- 1		- 1	μA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			- 50		
		$V_{DS}$ = - 60 V, $V_{GS}$ = 0 V, $T_{J}$ = 175 °C			- 250	1	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 10 V	- 120			Α	
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 30 A		0.015	0.019	<del>)</del>	
	Р	$V_{GS}$ = - 10 V, I <sub>D</sub> = - 30 A, T <sub>J</sub> = 125 °C			0.033		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS}$ = - 10 V, I <sub>D</sub> = - 30 A, T <sub>J</sub> = 175 °C			0.041	Ω	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 20 A		0.020	0.025		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 50 A	20			S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			3500		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V, V_{DS} = -25 V, f = 1 MHz$		390			
Reverse Transfer Capacitance	C <sub>rss</sub>			290			
Total Gate Charge <sup>c</sup>	Qg			76	115	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -55$ A		16			
Gate-Drain Charge <sup>c</sup>	Q <sub>qd</sub>			19			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		5.2		Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			12	20		
Bise Time <sup>c</sup>	t <sub>r</sub>	V <sub>DD</sub> = - 30 V, R <sub>I</sub> = 0.54 Ω		15	25	- ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong$ - 55 A, V <sub>GEN</sub> = - 10 V, R <sub>g</sub> = 2.5 Ω		80	120		
Fall Time <sup>c</sup>	t <sub>f</sub>			230	350		
Source-Drain Diode Ratings and Cha		Γ <sub>0</sub> = 25 °C <sup>b</sup>					
Continuous Current	I <sub>S</sub>				- 110		
Pulsed Current	I <sub>SM</sub>				- 240	А	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = - 50 A, V <sub>GS</sub> = 0 V		- 1	- 1.5	V	
Reverse Recovery Time	t <sub>rr</sub>			45	68	ns	
Peak Reverse Recovery Current		I <sub>F</sub> = - 50 A, di/dt = 100 A/μs		- 2.6	- 4	A	
Toak neverse neoovery ourient	I <sub>RM(REC)</sub>	$r_{\rm F} = -30$ Å, $u/ut = 100$ Å/µs		0.059	- 4	A	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

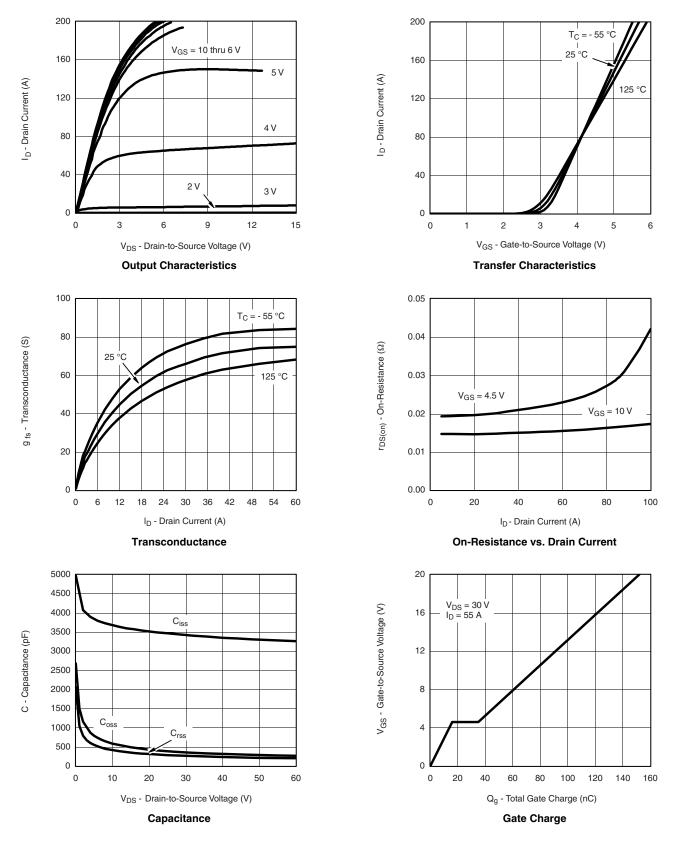
Document Number: 73059 S12-3070-Rev. D, 24-Dec-12



# SUM55P06-19L

Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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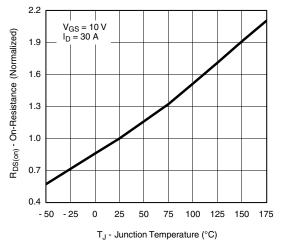
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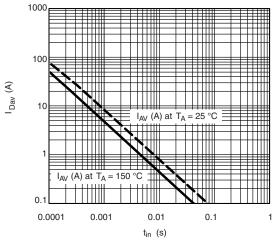


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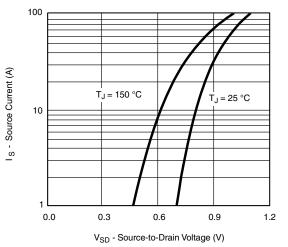
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



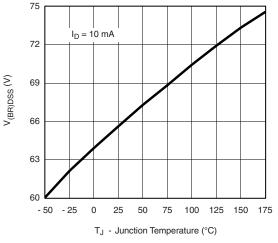
**On-Resistance vs. Junction Temperature** 



Avalanche Current vs. Time



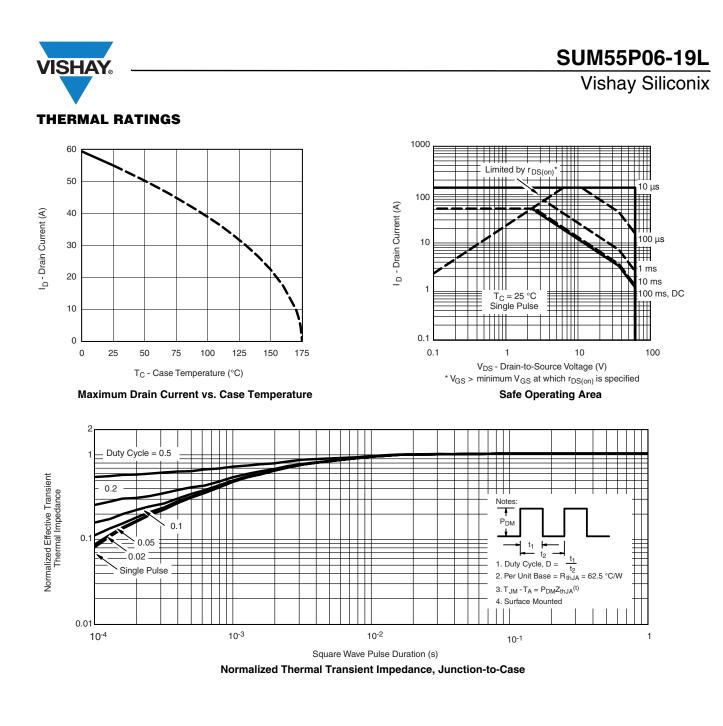
Source-Drain Diode Forward Voltage



Drain Source Breakdown vs.Junction Temperature

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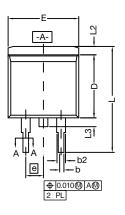


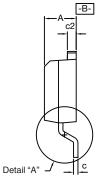
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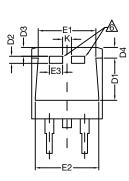


**Vishay Siliconix** 

TO-263 (D<sup>2</sup>PAK): 3-LEAD

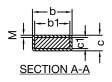








DETAIL A (ROTATED 90°)



		INCHES		MILLIMETERS			
DIM.		MIN.	MAX.	MIN.	MAX.		
А		0.160	0.190	4.064	4.826		
b		0.020	0.039	0.508	0.990		
	b1	0.020	0.035	0.508	0.889		
	b2	0.045	0.055	1.143	1.397		
с*	Thin lead	0.013	0.018	0.330	0.457		
	Thick lead	0.023	0.028	0.584	0.711		
c1	Thin lead	0.013	0.017	0.330	0.431		
CI	Thick lead	0.023	0.027	0.584	0.685		
	c2	0.045	0.055	1.143	1.397		
	D	0.340	0.380	8.636	9.652		
D1		0.220	0.240	5.588	6.096		
D2		0.038	0.042	0.965	1.067		
D3		0.045	0.055	1.143	1.397		
	D4	0.044	0.052	1.118	1.321		
	E	0.380	0.410	9.652	10.414		
	E1	0.245	-	6.223	-		
	E2	0.355	0.375	9.017	9.525		
	E3	0.072	0.078	1.829	1.981		
	е	0.100	0.100 BSC		BSC		
	К	0.045	0.055	1.143	1.397		
	L	0.575	0.625	14.605	15.875		
	L1	0.090	0.110	2.286	2.794		
L2		0.040	0.055	1.016	1.397		
	L3	0.050	0.070	1.270	1.778		
	L4	0.010 BSC 0.2		0.254	4 BSC		
	М	-	0.002	-	0.050		
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843							

#### Notes

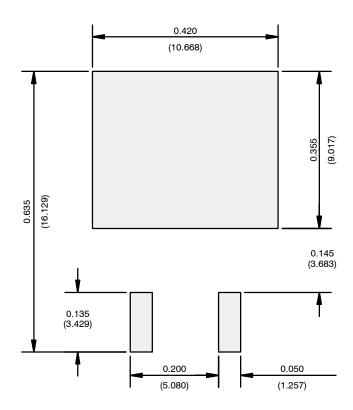
- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25  $\,\%\,$  of L1 can fall above seating plane by
- max. 8 mils. 3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB.
  - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



### **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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